

Seat No.:	Q. Paper Code: FTC-A-032		SET	P	
	Fabtech Technical Campus, College of Engineering & Research, Sangola				
	(An Autonomous Institute)				
	Electrical Engineering, Electronics & telecommunication Engineering				
	Academic Year: -2025-26, Semester-I				
<b>Electrical and Electronics components (25UET11003)</b>					
<b>Regular End Semester Examination 2025-26 [Dec./Jan.]</b>					
<b>Class:</b>	F. Y. B. Tech.	<b>Day &amp; Date:</b>	Monday, 19/01/2026		
<b>Duration:</b>	03 Hrs.	<b>Max. Marks:</b>	60 Marks		
<b>Time:</b>	10:00 AM TO 01:00 PM				
<b>Instructions:</b>					
1) Q. No. 1 is compulsory. It should be solved in the first 30 minutes in the Page No.3 of answersheet.					
2) Don't forget to mention the question paper set (P/Q/R) on the top of the page 3.					
<b>Q. 1</b>	<b>Multiple Choice Questions (MCQs) Each question carries 1 mark</b>			<b>Marks: 10</b>	
				<b>CO</b>	<b>BL</b>
1	Which of the following is a type of fixed resistor? a) LDR b) Potentiometer c) Thermistor d) Carbon film resistor			1	1
2	Inductor opposes change in: a) Voltage b) Current c) Power d) Resistance			1	2
3	Relay is a type of: a) Mechanical switch b) Static switch c) Electronic switch d) Thermal switch			2	2
4	Which cable is preferred for long-distance communication? a) Coaxial cable b) Twisted pair cable c) Fiber optic cable d) Ribbon cable			2	2
5	Which is a fast-switching diode? a) Zener diode b) Schottky diode c) Varactor diode			3	2

	d) Tunnel diode		
6	Which device is used for triggering TRIAC? a) DIAC b) SCR c) Zener d) MOSFET	3	2
7	FET is a: a) Current-controlled device b) Voltage-controlled device c) Magnetic-controlled device d) Power-controlled device	4	2
8	JFET stands for: a) Junction Field Effect Transistor b) Junction Feedback Electric Transistor c) Joint Field Electric Transistor d) None of these	4	2
9	Which IC package is surface-mount? a) DIP b) SOT c) TO-92 d) Metal can	5	2
10	SMD stands for: a) Surface Mount Device b) Surface Metal Diode c) Silicon Mounted Design d) Semiconductor Mounted Device	5	1

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Q. No.	Questions			Marks	CO	BL
<b>Q. 2</b>	<b>Attempt any two of the following</b>			<b>10</b>		
1	Define resistor, capacitor, and inductor with symbols.			5	1	1
2	Explain Inductor its types and Applications			5	1	2
3	Explain the color-coding system for resistors with an example.			5	1	2
<b>Q. 3</b>	<b>Attempt any two of the following</b>			<b>10</b>		
1	Define and classify switches (SPST, SPDT, DPST, DPDT) with neat symbols.			5	2	2
2	Draw and explain the working of a toggle switch.			5	2	3
3	Write short notes on push-button and rotary switches.			5	2	3
<b>Q. 4</b>	<b>Attempt any two of the following</b>			<b>10</b>		
1	Define a diode and explain its VI characteristics and Application			5	3	3
2	Define Transistor and explain its Types and Application			5	3	3
3	Define SCR and explain its VI characteristics and Application			5	3	3
<b>Q. 5</b>	<b>Attempt any two of the following</b>			<b>10</b>		
1	Draw and explain the structure of an NPN transistor.			5	4	2

2	Explain the working of a MOSFET with a neat diagram.	5	4	3
3	Compare BJT and FET .	5	4	4
<b>Q. 6</b>	<b>Attempt any two of the following</b>	<b>10</b>		
1	Explain the basic concept and structure of ICs.	5	5	2
2	Describe the steps involved in IC fabrication.	5	5	3
3	Explain IC classification based on scale of integration (SSI, MSI, LSI, VLSI).	5	5	2

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				<b>CO</b>	<b>BL</b>
1	Which device is used for triggering TRIAC? a) DIAC b) SCR c) Zener d) MOSFET			3	2
2	FET is a: a) Current-controlled device b) Voltage-controlled device c) Magnetic-controlled device d) Power-controlled device			4	2
3	JFET stands for: a) Junction Field Effect Transistor b) Junction Feedback Electric Transistor c) Joint Field Electric Transistor d) None of these			4	2
4	Which IC package is surface-mount? a) DIP b) SOT c) TO-92 d) Metal can			5	2
5	SMD stands for: a) Surface Mount Device b) Surface Metal Diode c) Silicon Mounted Design d) Semiconductor Mounted Device			5	1

6	Which of the following is a type of fixed resistor? a) LDR b) Potentiometer c) Thermistor d) Carbon film resistor	1	1
7	Inductor opposes change in: a) Voltage b) Current c) Power d) Resistance	1	2
8	Relay is a type of: a) Mechanical switch b) Static switch c) Electronic switch d) Thermal switch	2	2
9	Which cable is preferred for long-distance communication? a) Coaxial cable b) Twisted pair cable c) Fiber optic cable d) Ribbon cable	2	2
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<b>Q. 2</b>	<b>Attempt any two of the following</b>			<b>10</b>		
1	Define resistor, capacitor, and inductor with symbols.			5	1	1
2	Explain Inductor its types and Applications			5	1	2
3	Explain the color-coding system for resistors with an example.			5	1	2
<b>Q. 3</b>	<b>Attempt any two of the following</b>			<b>10</b>		
1	Define and classify switches (SPST, SPDT, DPST, DPDT) with neat symbols.			5	2	2
2	Draw and explain the working of a toggle switch.			5	2	3
3	Write short notes on push-button and rotary switches.			5	2	3
<b>Q. 4</b>	<b>Attempt any two of the following</b>			<b>10</b>		
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2	Define Transistor and explain its Types and Application			5	3	3
3	Define SCR and explain its VI characteristics and Application			5	3	3
<b>Q. 5</b>	<b>Attempt any two of the following</b>			<b>10</b>		
1	Draw and explain the structure of an NPN transistor.			5	4	2

2	Explain the working of a MOSFET with a neat diagram.	5	4	3
3	Compare BJT and FET .	5	4	4
<b>Q. 6</b>	<b>Attempt any two of the following</b>	<b>10</b>		
1	Explain the basic concept and structure of ICs.	5	5	2
2	Describe the steps involved in IC fabrication.	5	5	3
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2	Which IC package is surface-mount? a) DIP b) SOT c) TO-92 d) Metal can			5	2
3	SMD stands for: a) Surface Mount Device b) Surface Metal Diode c) Silicon Mounted Design d) Semiconductor Mounted Device			5	1
4	Which of the following is a type of fixed resistor? a) LDR b) Potentiometer c) Thermistor d) Carbon film resistor			1	1
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